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Silicon N-Channel MOS FET



ADE-208-1282 (Z) 1st. Edition Mar. 2001

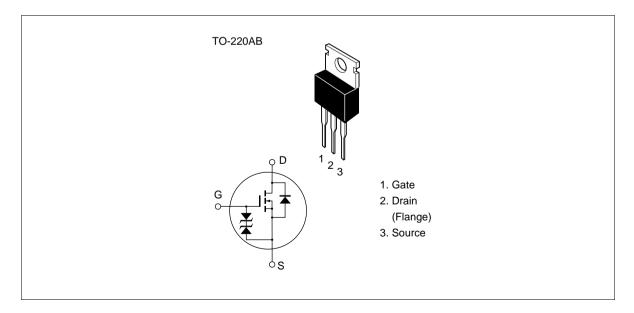
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK1402	V _{DSS}	600	V
	2SK1402A		650	
Gate to source voltage		V _{GSS}	±30	V
Drain current		I _D	4	А
Drain peak current		I _{D(pulse)} *1	16	А
Body to drain diode reverse drain current		l _{DR}	4	А
Channel dissipation		Pch*2	50	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

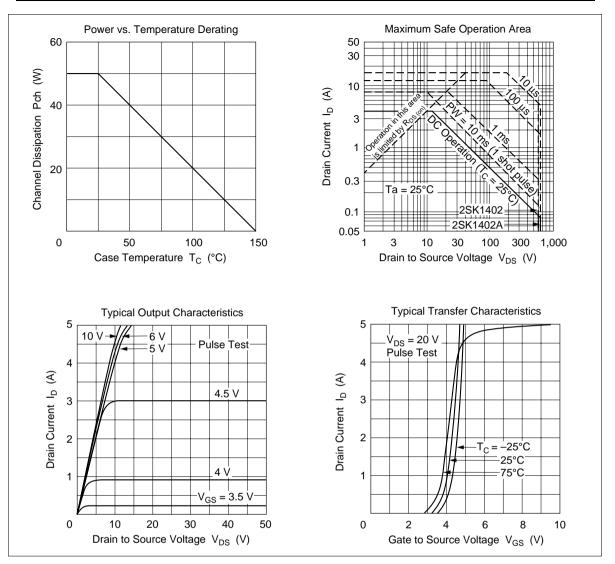
Notes: 1. $PW \le 10 \ \mu s$, duty cycle $\le 1\%$

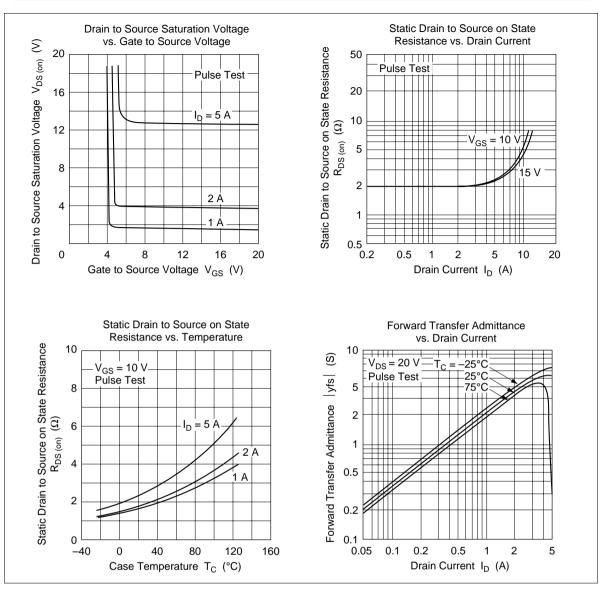
2. Value at T_c = 25° C

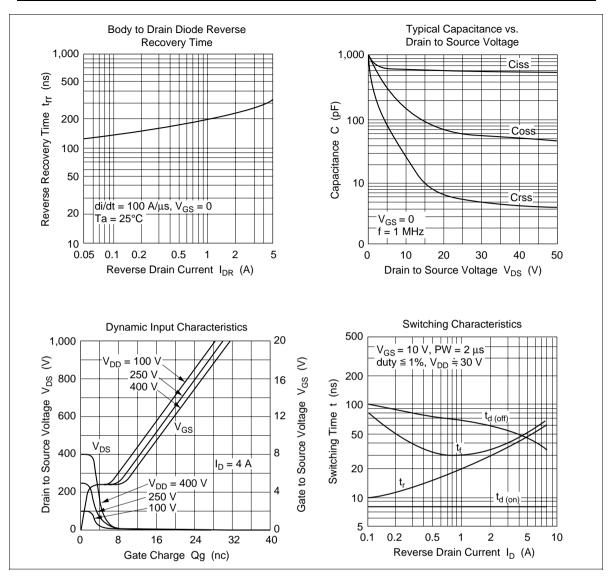
Electrical Characteristics (Ta = 25° C)

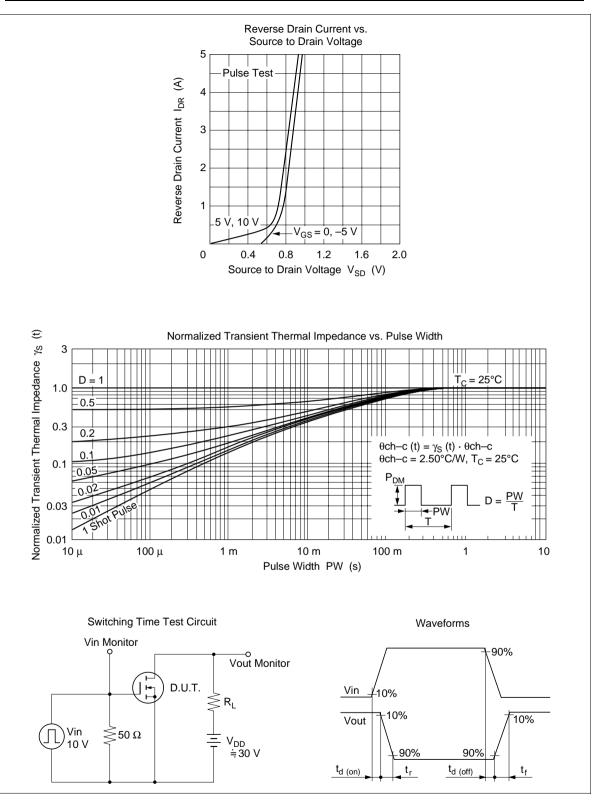
Item		Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source	K1402	$V_{(BR)DSS}$	600		_	V	$I_{\rm D} = 10 \text{ mA}, V_{\rm GS} = 0$
breakdown voltage	K1402A	_	650		_		
Gate to source break	down	$V_{(BR)GSS}$	±30	_	_	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak c	urrent	I _{GSS}	_		±10	μΑ	$V_{\text{GS}} = \pm 25 \text{ V}, \text{ V}_{\text{DS}} = 0$
Zero gate voltage	K1402	I _{DSS}	—		250	μΑ	$V_{\rm DS} = 500 \text{ V}, V_{\rm GS} = 0$
drain current	K1402A	_					$V_{\rm DS} = 550 \text{ V}, V_{\rm GS} = 0$
Gate to source cutoff	voltage	$V_{GS(off)}$	2.0		3.0	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$
Static drain to source	K1402	$R_{\text{DS(on)}}$	—	1.8	2.4	Ω	$I_{\rm D}$ = 2 A, $V_{\rm GS}$ = 10 V * ¹
on state resistance	K1402A	_	_	2.0	2.6		
Forward transfer adm	ittance	yfs	2.2	3.5	_	S	$I_{\rm D} = 2 \text{ A}, \text{ V}_{\rm DS} = 10 \text{ V}^{*1}$
Input capacitance		Ciss	—	600	_	pF	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0,$
Output capacitance		Coss	—	140	—	pF	f = 1 MHz
Reverse transfer capa	acitance	Crss	_	25	_	pF	_
Turn-on delay time		t _{d(on)}	—	8	_	ns	$I_{\rm D} = 2 \text{ A}, \text{ V}_{\rm GS} = 10 \text{ V},$
Rise time		t,	_	30	_	ns	R_= 15 Ω
Turn-off delay time		$t_{d(off)}$	—	60	_	ns	_
Fall time		t _f	—	35	_	ns	_
Body to drain diode fo voltage	orward	V_{DF}	—	0.9	—	V	$I_{F} = 4 \text{ A}, V_{GS} = 0$
Body to drain diode re recovery time	everse	t _{rr}	—	300	_	ns	$I_F = 4 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A/}\mu\text{s}$

Note: 1. Pulse test



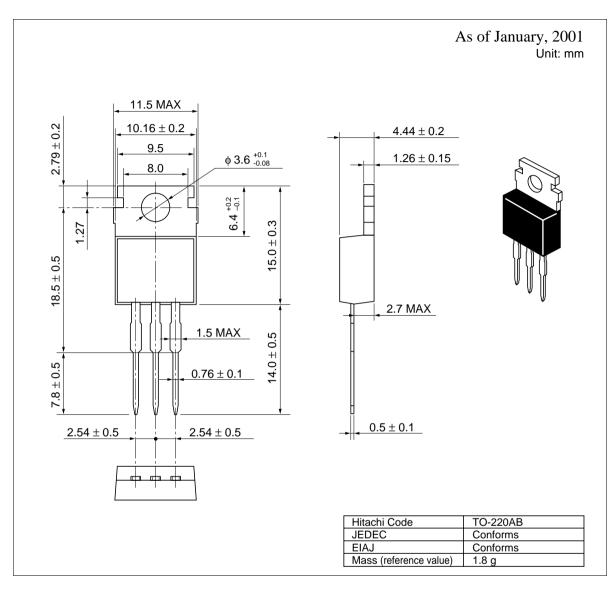






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Package Dimensions



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Hitachi, Ltd.

Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

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